

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT																
NATURE OF CONVEYANCE:	ASSIGNMENT																
CONVEYING PARTY DATA																	
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Ajay Kumar</td> <td>01/12/2007</td> </tr> <tr> <td>Madhavi R Chandrachood</td> <td>01/17/2007</td> </tr> <tr> <td>Richard Lewington</td> <td>01/12/2007</td> </tr> <tr> <td>Darin Bivens</td> <td>03/19/2007</td> </tr> <tr> <td>Amitabh Sabharwal</td> <td>01/15/2007</td> </tr> <tr> <td>Sheeba J Panayil</td> <td>02/01/2007</td> </tr> <tr> <td>Alan Hiroshi Ouye</td> <td>01/12/2007</td> </tr> </tbody> </table>		Name	Execution Date	Ajay Kumar	01/12/2007	Madhavi R Chandrachood	01/17/2007	Richard Lewington	01/12/2007	Darin Bivens	03/19/2007	Amitabh Sabharwal	01/15/2007	Sheeba J Panayil	02/01/2007	Alan Hiroshi Ouye	01/12/2007
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Alan Hiroshi Ouye	01/12/2007																
RECEIVING PARTY DATA																	
Name:	Applied Materials, Inc.																
Street Address:	3050 Bowers Avenue																
City:	Santa Clara																
State/Country:	CALIFORNIA																
Postal Code:	95054																
PROPERTY NUMBERS Total: 1																	
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13045239</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13045239												
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CORRESPONDENCE DATA																	
Fax Number:	(732)530-9808																
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>																	
Email:	mdiodato@pattersonsheridan.com																
Correspondent Name:	Patterson & Sheridan, LLP																
Address Line 1:	3040 Post Oak Boulevard																
Address Line 2:	Suite 1500																
Address Line 4:	Houston, TEXAS 77056																
ATTORNEY DOCKET NUMBER:	APPM/11454C1																

OP \$40.00 13045239

NAME OF SUBMITTER:

Keith P. Taboada

Total Attachments: 6

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ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses
of Inventors:

1)	AJAY KUMAR 10457 Manzanita Court Cupertino, CA 95014	2)	MADHAVI R. CHANDRACHOOD 392 Waverly Street Sunnyvale, CA 94086
3)	RICHARD LEWINGTON 602 Evangeline Way Hayward, CA 94544	4)	DARIN BIVENS 847 North Humbolt #405 San Mateo, CA 94401
5)	AMITABH SABHARWAL 994 Hampswood Way San Jose, CA 95120	6)	SHEEBA J. PANAYIL 2226 Schott Court Santa Clara, CA 95054
7)	ALAN HIROSHI OUYE 716 North Idaho Street San Mateo, CA 94401		

(hereinafter referred to as Assignors), have invented a certain invention entitled:

METHOD AND APPARATUS FOR PHOTOMASK PLASMA ETCHING

for which application for Letters Patent in the United States was filed on 10./30/2006,
under Serial No. 11/554,502; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International

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Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a conventional, division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.

2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting conventional, substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.

4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1) Jan 12, 2007 (DATE)


AJAY KUMAR

2) Jan. 17, 2007 (DATE)


MADHAVI R. CHANDRACHUD

3) JAN 12, 2007 (DATE)


RICHARD LEWINGTON

4) _____ (DATE)

DARIN BIVENS

5) Jan, 15, 2007 (DATE)


AMITABH SABHARWAL

6) _____ (DATE)

SHEEBA J. PANAYIL

7) 1/12/2007 (DATE)


ALAN HIROSHI OUYE

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3)	_____ (DATE)	_____
		RICHARD LEWINGTON
4)	<u>3/19/07</u> (DATE)	<u><i>Darin Bivens</i></u>
		DARIN BIVENS
5)	_____ (DATE)	_____
		AMITABH SABHARWAL

6) 2/1/07 (DATE) *Sheeba Panayil*
SHEEBA J. PANAYIL

7) _____ (DATE) _____
ALAN HIROSHI OUYE